# MN3718MFE, MN3718MAE

6mm (1/3 inch) 768H High-Resolution CCD Area Image Sensors

#### Overview

The MN3718MFE and MN3718MAE are 6mm (1/3 inch) Interline Transfer CCD (IT-CCD) solid state image sensor devices.

This device uses photodiodes in the optoelectric conversion section and CCDs for signal read out. The electronic shutter function has made possible an exposure time of 1/10000 seconds. Further, this device has the features of high sensitivity, low noise, broad dynamic range, and low smear.

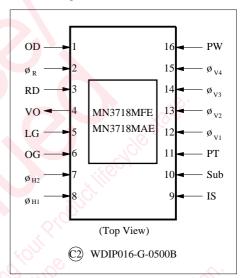
This device has a total of 410K pixels (811 horizontal × 494 vertical) and provides stable and clear images with a resolution of 480 horizontal TV-lines and 350 vertical TV-lines.

Type No.	Size	System	Color or B/W			
MN3718MFE	(1/2:1)	NTSC	Color			
MN3718MAE	6mm (1/3 inch)	EIA	B/W			

#### Features

- Total number of pixels: 811 (horizontal) × 494 (vertical)
- High sensitivity
- Low noise
- · Broad dynamic range
- Low smear
- Low image lag
- Electronic shutter function present
- No image distortion
- Small size enables design of compact equipment
- · High reliability
- 16 Pin DIL ceramic package (cerdip)

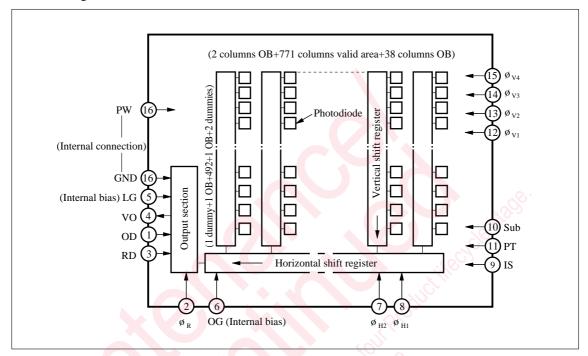
#### ■ Pin Assignments



#### Applications

- Compact lightweight camcoders
- Cameras for surveillance, measurement, and medical use

# ■ Block Diagram



# ■ Pin Descriptions

Pin No.	Symbol	Descriptions	Pin No.	Symbol	Descriptions
1	OD	Output drain	9	IS	Horizontal CCD input source
2	Ø <sub>R</sub>	Reset pulse	10	Sub	Substrate
3	RD	Reset drain	11	PT	P-well for protection circuit
4	VO	Video output	12	ø vı	Vertical shift register clock pulse (1)
5	LG	Output load transistor gate	13	Ø V2	Vertical shift register clock pulse (2)
6	OG	Output gate	14	Ø v3	Vertical shift register clock pulse (3)
7	Ø H2	Horizontal register clock pulse (2)	15	Ø V4	Vertical shift register clock pulse (4)
8	Ø HI	Horizontal register clock pulse (1)	16	PW	P-well

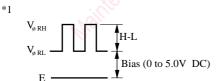
#### ■ Absolute Maximum Ratings and Operating Conditions

Parameter		Symbol	Rating Note 2)		Operating condition Note 1)			11.4	
		Symbol	min max		min typ ma		max	Unit	
Reset drain voltage	$V_{RD}$	- 0.2	18	14.5	15.0	15.5	V		
Output drain voltage		$V_{\mathrm{OD}}$	- 0.2	18	14.5	15.0	15.5	V	
Output load transistor gate	voltage Note 3)	$V_{LG}$		V					
Output gate voltage Note 3)		$V_{OG}$	(Supplied internally)						
Horizontal CCD input sou	rce voltage	V <sub>IS</sub>	-0.2		14.5 15.0 15.5			V	
Protection P well voltage		$V_{PT}$	-10.0 0.2		ø <sub>V(L)</sub> -1.2	ø <sub>V(L)</sub> - 1.0	ø <sub>V(L)</sub> - 0.7	V	
P well voltage	$V_{\mathrm{PW}}$	Reference	e voltage		0	_	V		
	H-L	V <sub>ØR (H-L)</sub> * 1	_	18	4.7	5.0	5.3	V	
Reset pulse voltage	Bias	V <sub>ø R (Bias)</sub> * 1	- 0.2	_	0	Adjust	5.0	V	
Horizontal register clock pulse voltage 1		V <sub>ø H1 (H)</sub>	_	18	4.7	5.0	5.3	V	
		V <sub>ø H1 (L)</sub>	- 0.2		0	0	90	V	
Horizontal register clock pulse voltage 2		V <sub>ø H2 (H)</sub>		18	4.7	5.0	5.3	V	
		V <sub>ø H2 (L)</sub>	- 0.2	_	0	0	0	V	
** ' 1 1'C ' '		V <sub>Ø V1 (H)</sub>		18	14.5	15.0	15.5	V	
Vertical shift register		V <sub>Ø V1 (M)</sub>	_		- 0.2	0	0.2	V	
clock pulse voltage 1		Vø V1 (L)	<b>-9</b>	_	-7.3	- 7.0	- 6.7	V	
Vertical shift register		V <sub>ø V2 (M)</sub>	1	15	0.8	1.0	1.2	V	
clock pulse voltage 2	V <sub>ø V2 (L)</sub>	<b>-9</b>		- 7.3	- 7.0	- 6.7	V		
W (1 1 1 1 0 1 )		V <sub>Ø</sub> v <sub>3 (H)</sub>		18	14.5	15.0	15.5	V	
Vertical shift register		V <sub>ø V3 (M)</sub>		4	-0.2	0	0.2	V.	
clock pulse voltage 3		V <sub>Ø V3 (L)</sub>	<b>-9</b>	11/20 1	<b>-</b> 7.3	- 7.0	- 6.7	V	
Vertical shift register		V <sub>ø V4 (M)</sub>	-,10	15	0.8	1.0	1.2	V	
clock pulse voltage 4		V <sub>ø V4 (L)</sub>	-9	A.	7.3	7.0	- 6.7	V	
		V <sub>Sub</sub> * 2	200	15.0	3.0	Adjust	14.5	V	
Substrate voltage		ø V <sub>Sub</sub> * 2	-0.2	45	24.5	25.0	25.5	V	
Operating temperature	Topr	- 10	70	11 - 11 m	25.0		°C		
Storage temperature	T <sub>stg</sub>	- 30	80	1 70	, *\( \int_{i,0}\).	2	°C		

Note 1) The initial setting of V<sub>Sub</sub> shall be 8.0V and shall be adjusted to the minimum voltage at which no blooming is caused at a light input of 100 times the standard value. The standard light input is the one when the exposure is done at an aperture of F/4 using a light source of 2856K and 1050nt, and placing a color temperature conversion filter LB-40 (Hoya) and an IR cutting filter CAW-500 (t=2.5mm) in the light path.

Note 2) Absolute maximum ratings: 
$$-0.2 < V_{Sub} - V_{PT} < +55 \text{ (V)}$$
 
$$-0.2 < V_{ØV} - V_{PT} < +24.5 \text{ (V)}$$

Note 3) The LG and OG pins should each be grounded via a capacitor of  $0.0477\mu\text{F}$  or more.





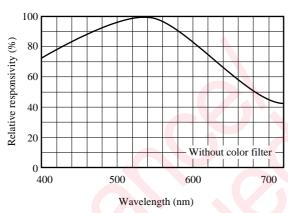


#### ■ Optical Characteristics

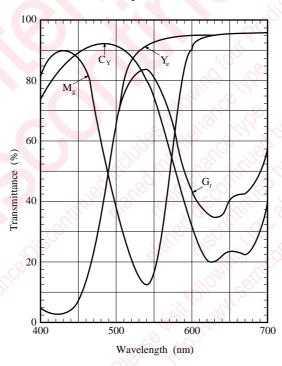
	Color	Valid	pixels	S/N	Saturation output	Sensitivity F8	Vertical smear	Image lag	Horizontal resolution	Vertical resolution
Type No.	or B/W	Н	V	typ. (dB)	typ. (mV)	typ. (mV)	Sm typ. (%)	typ. (%)	typ. (TV-lines)	typ. (TV-lines)
MN3718MFE	Color	771	492	60	700	300	0.01	0	480	350
MN3718MAE	B/W	771	492	60	1,000	350	0.01	0	550	350

# ■ Graphs of Characteristics





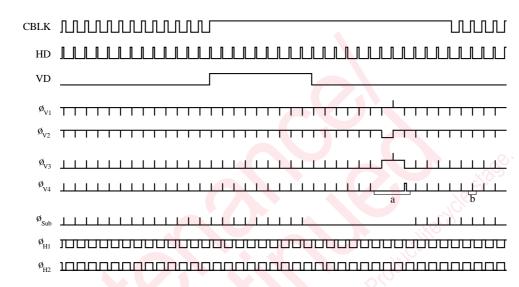
# Color Filter Spectral Characteristics



- Example of Recommended Driving Pulses
- V Rate timing

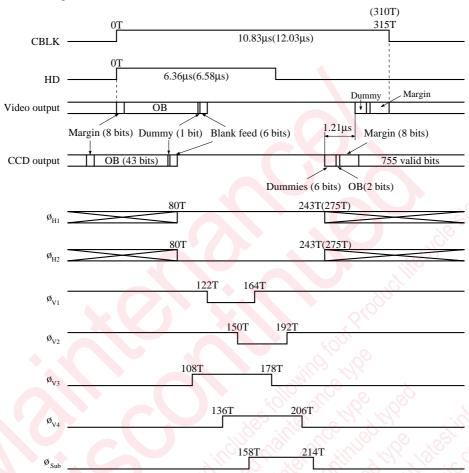
< Field A >

< Field B >

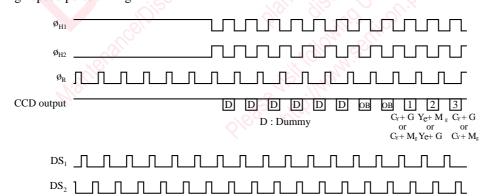


Ø<sub>V4</sub>

### • H Rate timing



# • High speed pulse timing



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